

Product End-of-Life Disassembly Instructions

Product Category: Calculators

Marketing Name / Model [List multiple models if applicable.]

HP MSR 1U HMIM Adapter Module (JG416A)

Purpose: The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

1.0 Items Requiring Selective Treatment

- 1.1 Items listed below are classified as requiring selective treatment.
- 1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

| Item Description | Notes | Quantity of items included in product |
|------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|------------------------------------------------|
| Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA) | With a surface greater than 10 sq cm | 1 |
| Batteries | All types including standard alkaline and lithium coin or button style batteries | 0 |
| Mercury-containing components | For example, mercury in lamps, display backlights, scanner lamps, switches, batteries | 0 |
| Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm | Includes background illuminated displays with gas discharge lamps | 0 |
| Cathode Ray Tubes (CRT) | | 0 |
| Capacitors / condensers (Containing PCB/PCT) | | 0 |
| Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height | | 0 |
| External electrical cables and cords | | 0 |
| Gas Discharge Lamps | | 0 |
| Plastics containing Brominated Flame Retardants weighing > 25 grams (not including PCBs or PCAs already listed as a separate item above) | | 0 |
| Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner | Include the cartridges, print heads, tubes, vent chambers, and service stations. | 0 |
| Components and waste containing asbestos | | 0 |
| Components, parts and materials containing refractory ceramic fibers | | 0 |
| Components, parts and materials containing radioactive substances | | 0 |

2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

| Tool Description | Tool Size (if applicable) |
|------------------|---------------------------|
| Screw driver | 2# |
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3.0 Product Disassembly Process

- 3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:
- 1. Unscrew the screws on PCB 1, and then remove PCB 1.
- 2. Unscrew the screws on card 2, and then remove card 2.
- 3. Unscrew the screws on part 3, and then remove part 3.
- 4. Remove part 4 from the panel 6.
- 5. Unscrew the screws on panel 6, and then remove panel 6.
- 3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).

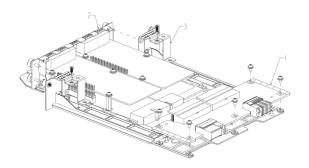


Figure 1 Treatments to the product

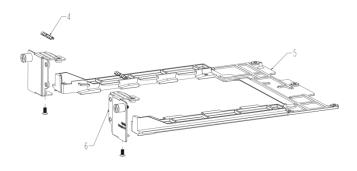


Figure 2 Treatments to the product

3.3 Material of the facility built

| Facility | Components | Material | Weight(g) | Weight percentage | Selective treatment for materials and components | Details |
|----------|------------|----------------|-----------|-------------------|-----------------------------------------------------------|--------------|
| | 1 | Complex PWB | 123 | 17.8% | The surface of PCB is greater than 10 square centimeters; | |
| | 5 | Al | 138 | 18.9% | | AL recycling |
| | 6 | Fe | 24.3*2 | 7.6% | | Fe recycling |

4. Revised record

| Date | Version | Author | Modify content |
|------------|---------|---------|-----------------|
| 2012.12.12 | V0 | Liu Jia | Initial version |

EL-MF877-00 Template Revision B